

## T591D477M2R5ATE009

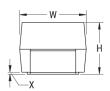
T591

**General Information** 

Series

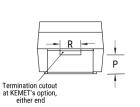
T591, Tantalum, Polymer Tantalum, 470 uF, 20%, 2.5 VDC, SMD, Polymer, Molded, Low ESR, 9 mOhms, 7343, Height Max = 3.1mm

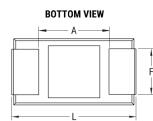
CATHODE (-) END VIEW



ANODE (+) END VIEW

SIDE VIEW





Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Low ESR
Features	Automotive
RoHS	Yes
Termination	Tin
Qualifications	AEC-Q200 (Limited 500 Hrs 85C/85% RH/Ur)
AEC-Q200	Subject to PPAP/PSW and change control
Component Weight	434.8 mg
Shelf Life	52 Weeks
MSL	3

Click	here	for	the	ЗD	model.
	nere	101	uie	20	model.

Dimensions	
Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
Н	2.8mm +/-0.3mm
Т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
В	0.5mm +/-0.15mm
Р	0.9mm REF
R	1mm REF
Х	0.1mm +/-0.1mm

T-

Packaging Specifications	
Packaging	T&R, 178mm
Packaging Quantity	500

Specifications	
Capacitance	470 uF
Capacitance Tolerance	20%
Voltage DC	2.5 VDC (105C), 1.68 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	105°C
Humidity	85C, 85% RH, load, 500 Hours
<b>Dissipation Factor</b>	10% 120Hz 25C
Failure Rate	N/A
Resistance	9 mOhms (100kHz 25C)
Ripple Current	7070 mA (rms, 100kHz 45C), 4949 mA (rms, 105C), 1768 mA (rms, 125C)
Leakage Current	117.5 uA (5min 25°C)

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)